

Semico Fab Database Update Summary First Half 2016

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Below are the column headings included in the Excel workbook accompanying this Word document. There are 940 rows in the workbook:

Status	450mm capable
Company	Full Capacity (w/mo)
FabName	Full Capacity (8-in Equiv/ mo)
Region	Construction Start
Country	Initial Prod Yr
City	Vol Prod Yr
State/ Region	Yr Closed or Closing
Special Substrate	Empl
University	Total Capex (millions)
Development	Site Size
IDM	Total Fab Size (K sq. m)
Foundry	Cleanroom Size (K sq. m)
Process Type	
Products	
Logic	
ASSPs	
ASICs	
Analog	
Discretes	
Passives	
Opto	
DRAM	
Mobile RAM	
SRAM	
NAND	
NOR	
Other NV Memory	
MEMS	
Image Sensors	
Oth Sensors	
LED	
LED Drivers	
LCD Drivers	
Other	
Bipolar	
Current Process Tech (nm)	
FinFET	
Wafer Size (mm)	